

	Date: 2023/6/5	Halogen	RoHS Certificate Green Partner
Custon	ner :		
TAI-TECH P/N:	HFZ2012PV-300T85-HD		
CUSTOMER P/N:			
DESCRIPTION:			
QUANTITY:	pcs		
REMARK:			
C	ustomer Approval Feedback		
	፪ 慶 科 技 股 份 有 限 2 H Advanced Electronics Co.		
□西北臺慶科技股份有限公司 TAI-TECH Advanced Electronics Co., Ltd <u>Headquarter:</u> NO.1 YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG	з-меі, Sales Dep.		
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http://www.tai-tech.com.tw E-mail: sales@tai-tech.com.tw]Office: 深圳辦公室 11BC,Building B Fortune Plaza,NO.7002, Shennan Avenue, I District Shenzhen	[≘] utian Eric Guan	蒯青榮	
http://www.tai-tech.com.tw E-mail: sales@tai-tech.com.tw □Office: 深圳辦公室 11BC,Building B Fortune Plaza,NO.7002, Shennan Avenue, I District Shenzhen TEL: +86-755-23972371 FAX: +86-755-23972340 ■臺慶精密電子(昆山)有限公司 TAI-TECHADVANCED ELECTRONICS(KUNSHAN) C	Eric Guan Ec., LTD R&D Center	蒯青榮	
http://www.tai-tech.com.tw E-mail: sales@tai-tech.com.tw ❑Office: 深圳辦公室 11BC,Building B Fortune Plaza,NO.7002, Shennan Avenue, I District Shenzhen	Eric Guan Ec., LTD R&D Center	蒯青榮 CHECKED	DRAWN

TAI-TECH

High Current Ferrite Chip Bead(Lead Free)

HFZ2012PV-300T85-HD

ECN HISTORY LIST						
REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN	
1.0	22/11/16	新發行	鄧福興	浦冬生	王俞琴	
2.0	22/12/05	更新可靠度及更正 Reflow 敘述	鄧福興	浦冬生	王俞琴	
		1				
備						
註						

High Current Ferrite Chip Bead(Lead Free)

HFZ2012PV-300T85-HD

RoHS

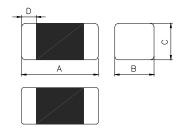
Certificate

Green Partner

1. Features

- 1. Monolithic inorganic material construction.
- 2. Closed magnetic circuit avoids crosstalk.
- 3. Suitable for reflow soldering.
- 4. Shapes and dimensions follow E.I.A. spec.
- 5. High Current Bead Low RDC
- 6. Excellent solder ability and heat resistance.
- 7. High reliability. Reliability test meet AEC-Q200.
- 8. 100% Lead(Pb) & Halogen-Free and RoHS compliant.
- 9. Low DC resistance structure of electrode to prevent wasteful electric power consumption.
- 10. Operating Temperature: -55~+150°C (Including self-temperature rise)

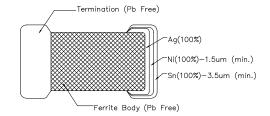
2. Dimensions



Chip Size				
Α	2.00±0.20			
В	1.25±0.20			
С	0.85±0.20			
D	0.50±0.30			
Units: mm				

3. Part Numbering



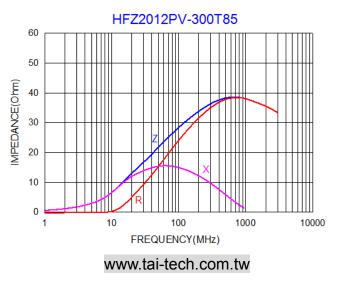


4. Specification

Tai-Tech	Impedance (Ω)	Test Frequency	DC Resistance	Rated Current
Part Number		(Hz)	(Ω) max.	(mA) max.
HFZ2012PV-300T85-HD	30±25%	60mV/100M	0.004	8500

• Rated current: based on temperature rise test

• In compliance with EIA 595



Impedance-Frequency Characteristics

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5. Reliability and Test Condition

Item	Performance	Test Condition
Series No.	HFZ	
Operating Temperature	-55~+150℃ (Including self-temperature rise)	
Transportation Storage Temperature	-55~+150℃ (on board)	For long storage conditions, please see the Application Notice
Impedance (Z)		Agilent4291 Agilent E4991 Agilent4287 Agilent4287
C Resistance		Agilent16192 Agilent 4338
Rated Current		DC Power Supply Over Rated Current requirements, there will be some risk
Temperature Rise Test	Rated Current < 1A ΔT 20℃Max Rated Current ≧ 1A ΔT 40℃Max	 Applied the allowed DC current. Temperature measured by digital surface Thermometer.
High Temperature Exposure(Storage)		Preconditioning:Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Temperature : 150±2°C Duration : 1000hrs Min. Measured at room temperature after placing for 24±2 hrs
	Appearance : No damage. Impedance : within±15% of initial value RDC : Within ±15% of initial value and shall not exceed the specification value	Preconditioning:Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Condition for 1 cycle Step1 : -55±2°C 30min Min. Step2 : 150±2°C transition time 1min MAX. Step3 : 150±2°C 30min Min. (Bead) Step4 : Low temp. transition time 1min MAX. Number of cycles : 1000 Measured at room temperature after placing for 24±2 hrs
Biased Humidity (AEC-Q200)	Appearance : No damage.	Preconditioning:Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Humidity :85±3%RH. Temperature :85±2°C. Duration :1000 hrs Min. Measured at room temperature after placing for 24±2 hrs
High Temperature Operational Life	Impedance : within±15% of initial value RDC : Within ±15% of initial value and shall not exceed the specification value	Preconditioning:Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Temperature : 150±2°C Duration : 1000hrs Min. with 100% rated current. Measured at room temperature after placing for 24±2 hrs
External Visual	Appearance : No damage.	Inspect device construction, marking and workmanship. Electrical Test not required.
Physical Dimension	According to the product specification size measurement	According to the product specification size measurement
Resistance to Solvents	Appearance : No damage.	Add aqueous wash chemical - OKEM clean or equivalent.

Item	Performance	Test Condition				
		Preconditioning:Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Test condition:				
Mechanical Shock		Туре	Peak alue (g's)	Normal duration (D) (ms)	Wave form	Velocity change (Vi)ft/sec
		SMD	100	6	Half-sine	12.3
		Lead	100	6	Half-sine	12.3
				each o ces(18shoo		along 3
Vibration	Appearance : No damage. Impedance : within±15% of initial value RDC : Within ±15% of initial value and shall not exceed the specification value	Preconditioning:Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Oscillation Frequency: $10Hz \sim 2KHz \sim 10Hz$ for 20 minute Equipment : Vibration checker Total Amplitude:5g Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations) \circ				
				VIL-STD-2 cycles: 1	202 Conditi	on B)
Resistance to Soldering		Temperat (°C)		Time (s)	Temperate ramp/imm and emers	ersion
Heat		260 ±5 (solder t	emp)	10 ±1	25mm/s:	±6mm/s
		Depth: completely cover the termination				on
Thermal shock	Appearance : No damage. Impedance : within±15% of initial value RDC : Within ±15% of initial value and shall not exceed the specification value	times.(I Reflow F Conditio Step1 : Step2 : Step3 : Number	PC/JED Profiles n for 1 c -55±2℃ 150±2℃ 150±2℃ of cycle ed at ro	EC J-STD 15±1min within 20 15±1min s : 300		ssification
ESD	Appearance : No damage.	COMPO Wavefor Test met Test mod	NENT F m to a C hod: AE de : Cor		get 02 large	t PASSIVE Discharge
Solder ability	More than 95% of the terminal electrode should be covered with solder.	a.Metho @235°C b. Metho ± 15 min	d B, ±5°C Te od D cat	4 hrs (est time:5 +	ᡚ155°C c ⊦0/-0.5 sec steam agir	onds.
Electrical Characterization	Refer Specification for Approval	Summa Standa			, Max, Me	ean and
Flammability	Electrical Test not required.	V-0 or V	/-1 are	accepta	ble.	
		1				

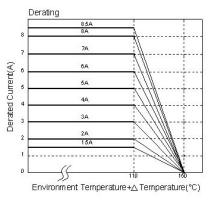
TAI-TECH

KBM01-230600107 P5

Item		Performance	Test Condition
Board Flex	Appearance : No damage.	Support Sup	Preconditioning:Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles Place the 100mm X 40mm board into a fixture similar to the one shown in below Figure with the component facing down. The apparatus shall consist of mechanical means to apply a force which will bend the board (D) x = 2 mm minimum. The duration of the applied forces shall be 60 (+ 5) sec. The force is to be applied only once to the board.
Terminal strength	Appearance : No damage.	racika 0.5 mm DUT substrate press tool sheer force	Preconditioning:Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles With the component mounted on a PCB with the device to be tested, apply a 17.7 N (1.8 Kg) force to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to thecomponent being tested.

**Derating Curve

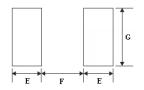
For the ferrite chip bead which withstanding current over 1.5A, as the operating temperature over $110^\circ\!\!\mathbb{C}$, the derating current information is necessary to consider with. For the detail derating of current, please refer to the Derated Current vs. Operating Temperature curve.



6. Soldering and Mounting

6-1. Recommended PC Board Pattern

	Chip Size					Pattern		
Series	Туре	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)	F(mm)	G(mm)
HFZ	2012	2.0±0.20	1.25±0.20	0.85±0.20	0.50±0.30	1.05	1.00	1.45



PC board should be designed so that products can prevent damage from mechanical stress when warping the board.

6-2. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

TAI-TECH 6-2.1 Soldering Reflow:

Recommended temperature profiles for lead free re-flow soldering in Figure 1. Table 1.1&1.2 (J-STD-020E)

6-2.2 Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. (Figure 2.)

 $\,\cdot$ Preheat circuit and products to 150 $^\circ\!{\rm C}$ $\boldsymbol{\cdot}$ Never contact the ceramic with the iron tip

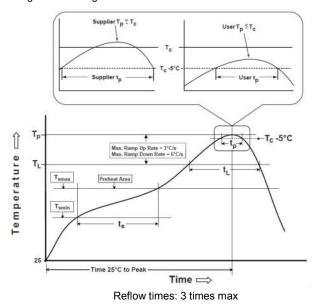
- \cdot 350 $^\circ\!\mathrm{C}$ tip temperature (max)

· 1.0mm tip diameter (max)

 Use a 20 watt soldering iron with tip diameter of 1.0mm Limit soldering time to 4~5sec.

Fig.2 Iron soldering temperature profiles

Fig.1 Soldering Reflow



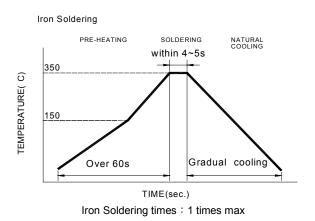


Table (1.1): Reflow Profiles

Profile Type:	Pb-Free Assembly
Preheat -Temperature Min(T _{smin}) -Temperature Max(T _{smax}) -Time(t _s)from(T _{smin} to T _{smax})	150℃ 200℃ 60-120seconds
Ramp-up rate(T₋to T _p)	3℃/second max.
Liquidus temperature(T _L) Time(t _L)maintained above T _L	217℃ 60-150 seconds
Classification temperature(T _c)	See Table (1.2)
$Time(t_p)$ at Tc- 5 $^\circ\!\mathbb{C}$ (Tp should be equal to or less than Tc.)	< 30 seconds
Ramp-down rate(T_p to T_L)	6℃ /second max.
Time 25℃ to peak temperature	8 minutes max.

Tp: maximum peak package body temperature, Tc: the classification temperature. For user (customer) Tp should be equal to or less than Tc.

Table (1.2) Package Thickness/Volume and Classification Temperature (T_c)

	Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
	<1.6mm	260°C	260°C	260°C
PB-Free Assembly	1.6-2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

Reflow is referred to standard IPC/JEDEC J-STD-020E .

6-2.3 Solder Volume:

Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance. Solder shall be used not to be exceed as shown in right side:

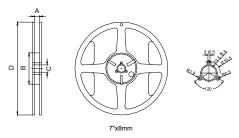
Minimum fillet height = soldering thickness + 25% product height





7. Packaging Information

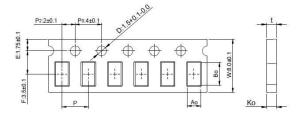
7-1. Reel Dimension



Тур	e	A(mm)	B(mm)	C(mm)	D(mm)
7"x8r	nm	9.0±0.5	60±2	13.5±0.5	178±2

7-2.1 Tape Dimension / 8mm

Material of taping is paper

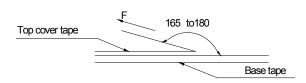


Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	t(mm)
201209	2.10±0.05	1.30±0.05	0.95±0.05	4.0±0.10	0.95±0.05

7-3. Packaging Quantity

Chip Size	201209
Chip / Reel	4000
Inner box	20000
Middle box	100000
Carton	200000

7-4. Tearing Off Force



The force for tearing off cover tape is 15 to 60 grams in the arrow direction under the following conditions.

Room Temp.	Room Humidity	Room atm	Tearing Speed
(°C)	(%)	(hPa)	mm/min
5~35	45~85	860~1060	300

Application Notice

- Storage Conditions(component level)
- To maintain the solder ability of terminal electrodes:
- 1. TAI-TECH products meet IPC/JEDEC J-STD-020E standard-MSL, level 1.
- 2. Temperature and humidity conditions: Less than 40 $^\circ\! \mathbb C$ and 60% RH.
- 3. Recommended products should be used within 12 months from the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.

Transportation

- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.





測試報告 Test Report

號碼(No.): ETR22B04558 日期(Date): 06-Dec-2022

頁數(Page):1 of 15

西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)

臺慶精密電子(昆山)有限公司 (TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.)

慶邦電子元器件 (泗洪) 有限公司 (TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)

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江蘇省昆山市篷朗昆嘉高科技工業區郭澤路 (GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA)

中國,江蘇省,宿遷市,泗洪縣,經濟開發區杭州路南側,建設北路東側 (THE SOUTH HANGZHOU ROAD AND THE EAST JIANSHE ROAD, ECONOMIC DEVELOPMENT ZONE, SIHONG COUNTY, SUQIANCITY, JIANGSU PROVINCE, P,R, CHINA)

以下測試樣品係由申請廠商所提供及確認 (The following sample(s) was/were submitted and identified by the applicant as):

樣品名稱(Sample Name) 樣品型號(Style/Item No.)	:	FERRITE CHIP BEAD · FERRITE CHIP INDUCTOR · ARRAY · MCF · MCM · YMV SERIES FERRITE CHIP BEAD · FERRITE CHIP INDUCTOR · ARRAY · MCF · MCM · YMV SERIES
=====================================	=== : :	======================================
測試需求(Test Requested) :		依據客戶要求進行測試‧測試項目請參閱測試結果表格。 (Testing item(s) is/are specified by client. Please refer to result table for testing item(s).)
測試結果(Test Results) :		請參閱下一頁 (Please refer to following pages.)

Troy Chang / Department Ma Signed for and on behalf SGS TAIWAN LTD. Chemical Laboratory - Taipei



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SGS Taiwan Ltd. 台灣檢驗科技股份有限公司



Test Report

號碼(No.): ETR22B04558 日期(Da

日期(Date): 06-Dec-2022

頁數(Page): 2 of 15

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測試部位敘述 (Test Part Description)

No.1 : 整體混測 (MIXED ALL PARTS)

測試結果 (Test Results)

測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result) No.1
鎘 (Cd) (Cadmium (Cd)) (CAS No.: 7440- 43-9)	參考IEC 62321-5: 2013 · 以感應耦合電漿發射光 譜儀分析。(With reference to IEC 62321-5: 2013, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
鉛 (Pb) (Lead (Pb)) (CAS No.: 7439-92-1)	參考IEC 62321-5: 2013,以感應耦合電漿發射光 譜儀分析。(With reference to IEC 62321-5: 2013, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
汞 (Hg) (Mercury (Hg)) (CAS No.: 7439- 97-6)	參考IEC 62321-4: 2013 + AMD1: 2017 · 以感應耦 合電漿發射光譜儀分析。(With reference to IEC 62321-4: 2013 + AMD1: 2017, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
六價鉻 Cr(VI) (Hexavalent Chromium Cr(VI)) (CAS No.: 18540-29-9)	參考IEC 62321-7-2: 2017 · 以紫外光-可見光分光 光度計分析。(With reference to IEC 62321-7-2: 2017, analysis was performed by UV-VIS.)	mg/kg	8	n.d.

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
一溴聯苯 (Monobromobiphenyl)		mg/kg	5	n.d.
二溴聯苯 (Dibromobiphenyl)		mg/kg	5	n.d.
三溴聯苯 (Tribromobiphenyl)		mg/kg	5	n.d.
四溴聯苯 (Tetrabromobiphenyl)	1 F	mg/kg	5	n.d.
五溴聯苯 (Pentabromobiphenyl)		mg/kg	5	n.d.
六溴聯苯 (Hexabromobiphenyl)		mg/kg	5	n.d.
七溴聯苯 (Heptabromobiphenyl)		mg/kg	5	n.d.
八溴聯苯 (Octabromobiphenyl)		mg/kg	5	n.d.
九溴聯苯 (Nonabromobiphenyl)		mg/kg	5	n.d.
十溴聯苯 (Decabromobiphenyl)	会考ⅠFC (2221 () 201F \\\\\[\\\[\\\[\\\[\\\[\\\[\\\[mg/kg	5	n.d.
多溴聯苯總和 (Sum of PBBs)	参考IEC 62321-6: 2015 · 以氣柏層析儀/頁譜儀分 析。(With reference to IEC 62321-6: 2015, analysis was performed by GC/MS.)	mg/kg	-	n.d.
一溴聯苯醚 (Monobromodiphenyl ether)		mg/kg	5	n.d.
二溴聯苯醚 (Dibromodiphenyl ether)		mg/kg	5	n.d.
三溴聯苯醚 (Tribromodiphenyl ether)		mg/kg	5	n.d.
四溴聯苯醚 (Tetrabromodiphenyl ether)		mg/kg	5	n.d.
五溴聯苯醚 (Pentabromodiphenyl ether)		mg/kg	5	n.d.
六溴聯苯醚 (Hexabromodiphenyl ether)		mg/kg	5	n.d.
七溴聯苯醚 (Heptabromodiphenyl ether)		mg/kg	5	n.d.
八溴聯苯醚 (Octabromodiphenyl ether)		mg/kg	5	n.d.
九溴聯苯醚 (Nonabromodiphenyl ether)		mg/kg	5	n.d.
十溴聯苯醚 (Decabromodiphenyl ether)		mg/kg	5	n.d.
多溴聯苯醚總和 (Sum of PBDEs)		mg/kg	-	n.d.

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SGS Taiwan Ltd. 台灣檢驗科技股份有限公司



Test Report

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西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result) No.1
鄰苯二甲酸丁苯甲酯 (BBP) (Butyl benzyl phthalate (BBP)) (CAS No.: 85-68-7)		mg/kg	50	n.d.
		mg/kg	50	n.d.
鄰苯二甲酸二(2-乙基己基)酯 (DEHP) (Di- (2-ethylhexyl) phthalate (DEHP)) (CAS No.: 117-81-7)		mg/kg	50	n.d.
鄰苯二甲酸二異丁酯 (DIBP) (Diisobutyl phthalate (DIBP)) (CAS No.: 84-69-5)		mg/kg	50	n.d.
鄰苯二甲酸二異癸酯 (DIDP) (Diisodecyl phthalate (DIDP)) (CAS No.: 26761-40- 0, 68515-49-1)		mg/kg	50	n.d.
鄰苯二甲酸二異壬酯 (DINP) (Diisononyl phthalate (DINP)) (CAS No.: 28553-12- 0, 68515-48-0)		mg/kg	50	n.d.
鄰苯二甲酸二正辛酯 (DNOP) (Di-n-octyl phthalate (DNOP)) (CAS No.: 117-84-0)		mg/kg	50	n.d.
鄰苯二甲酸二正戊酯 (DNPP) (Di-n- pentyl phthalate (DNPP)) (CAS No.: 131-18-0)		mg/kg	50	n.d.
鄰苯二甲酸二正己酯 (DNHP) (Di-n-hexyl phthalate (DNHP)) (CAS No.: 84-75-3)		mg/kg	50	n.d.

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Test Report

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result) No.1
 六溴環十二烷及所有主要被辨別出的異構物(HBCDD) (α- HBCDD, β- HBCDD, γ- HBCDD) (Hexabromocyclododecane (HBCDD) and all major diastereoisomers identified (α- HBCDD, β- HBCDD, γ- HBCDD)) (CAS No.: 25637-99-4, 3194-55-6 (134237-51-7, 134237-50-6, 134237-52-8)) 	參考IEC 62321-9: 2021 · 以氣相層析儀/質譜儀分 析。(With reference to IEC 62321-9: 2021, analysis was performed by GC/MS.)	mg/kg	20	n.d.
氟 (F) (Fluorine (F)) (CAS No.: 14762-94- 8)	參考BS EN 14582: 2016.以離子層析儀分析。 (With reference to BS EN 14582: 2016, analysis was performed by IC.)	mg/kg	50	n.d.
氯 (Cl) (Chlorine (Cl)) (CAS No.: 22537- 15-1)		mg/kg	50	n.d.
溴 (Br) (Bromine (Br)) (CAS No.: 10097- 32-2)		mg/kg	50	n.d.
碘 (I) (lodine (I)) (CAS No.: 14362-44-8)		mg/kg	50	n.d.
全氟辛烷磺酸及其鹽類 (PFOS and its salts) (CAS No.: 1763-23-1 and its salts)	參考CEN/TS 15968: 2010.以液相層析串聯質譜 儀分析。(With reference to CEN/TS 15968: 2010, analysis was performed by LC/MS/MS.)	mg/kg	0.01	n.d.
全氟辛酸及其鹽類 (PFOA and its salts) (CAS No.: 335-67-1 and its salts)		mg/kg	0.01	n.d.
聚氯乙烯 (Polyvinyl chloride) (PVC)	參考ASTM E1252: 2021 · 以傅立葉轉換紅外線光 譜儀及焰色法分析。(With reference to ASTM E1252: 2021, analysis was performed by FT-IR and Flame Test.)	**	-	Negative

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SGS Taiwan Ltd. 台灣檢驗科技股份有限公司



Test Report

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
(Test iteriis)	(Method)	(Onit)		No.1
銻 (Sb) (Antimony (Sb)) (CAS No.: 7440- 36-0)	- 參考US EPA 3052: 1996 · 以感應耦合電漿發射光	mg/kg	2	n.d.
砷 (As) (Arsenic (As)) (CAS No.: 7440- 38-2)	参考US EPA 3052. 1996,以愿應稱口龟浆發射元 譜儀分析。(With reference to US EPA 3052: 1996, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
鈹 (Be) (Beryllium (Be)) (CAS No.: 7440- 41-7)	1996, analysis was performed by ICP-OES.)	mg/kg	2	n.d.

備註(Note):

- 1. mg/kg = ppm ; 0.1wt% = 0.1% = 1000ppm
- 2. MDL = Method Detection Limit (方法偵測極限值)
- 3. n.d. = Not Detected (未檢出); 小於MDL / Less than MDL
- 4. "-" = Not Regulated (無規格值)
- 5. **= Qualitative analysis (No Unit) 定性分析(無單位)
- 6. Negative = Undetectable 陰性(未偵測到); Positive = Detectable 陽性(已偵測到)
- 7. 全氟辛烷磺酸及其鹽類包含等物質 (PFOS and its salts including): CAS No.: 1763-23-1, 2795-39-3, 29457-72-5, 29081-56-9, 70225-14-8, 56773-42-3, 251099-16-8, 307-35-7, 91036-71-4, 4021-47-0 and others.
- 8. 全氟辛酸及其鹽類包含等物質 (PFOA and its salts including): CAS No.: 335-67-1, 335-95-5, 2395-00-8, 335-93-3, 335-66-0, 3825-26-1 and others.
- 9. 樣品的測試是基於申請人要求混合測試,報告中的混合測試結果不代表其中個別單一材質的含量。 The sample(s) was/were analyzed on behalf of the applicant as mixing sample in one testing. The above result(s) was/were only given as the informality value.

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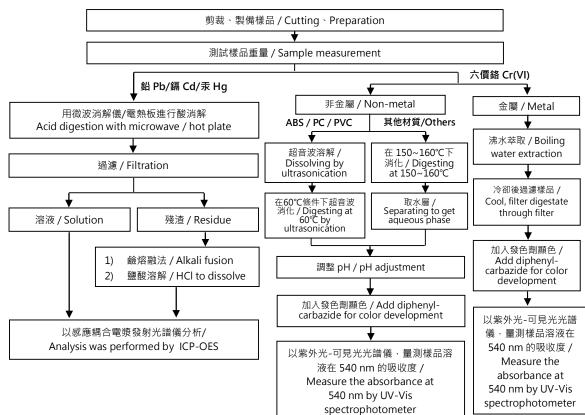
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重金屬流程圖 / Analytical flow chart of heavy metal

根據以下的流程圖之條件,樣品已完全溶解。(六價鉻測試方法除外)

These samples were dissolved totally by pre-conditioning method according to below flow chart.

 $(Cr^{6+} test method excluded)$



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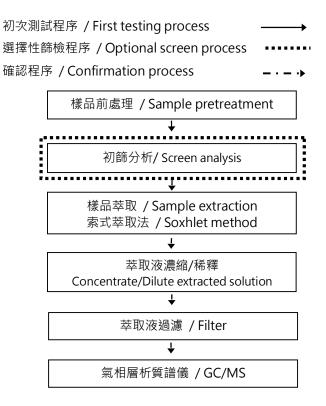
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多溴聯苯/多溴聯苯醚分析流程圖 / Analytical flow chart - PBBs/PBDEs



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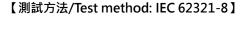
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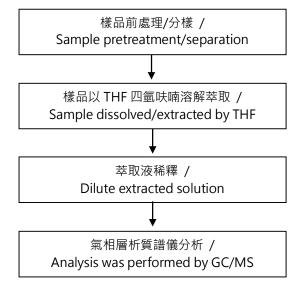
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可塑劑分析流程圖 / Analytical flow chart - Phthalate





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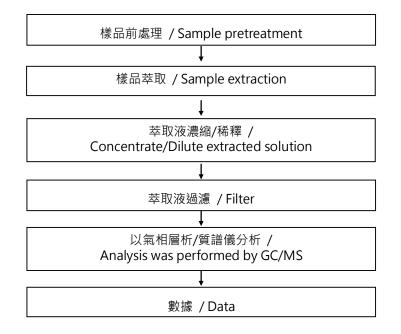
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六溴環十二烷分析流程圖 / Analytical flow chart - HBCDD

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頁數(Page): 11 of 15

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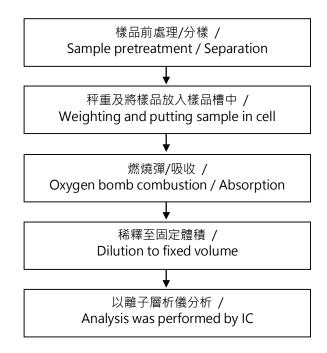
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慶邦電子元器件 (泗洪) 有限公司 (TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)

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鹵素分析流程圖 / Analytical flow chart - Halogen

25, Wu Chyuan 7th Road, New Taipei Industrial Park, Wu Ku District, New Taipei City, Taiwan Downloaded From Oneyac.com

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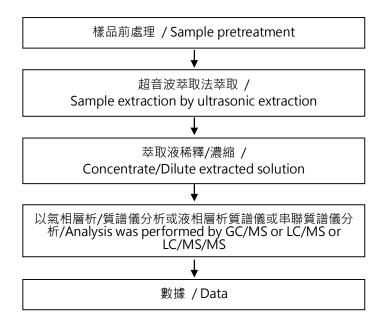
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全氟化合物(包含全氟辛酸/全氟辛烷磺酸/其相關化合物等等)分析流程圖 / Analytical flow chart – PFAS (including PFOA/PFOS/its related compound, etc.)



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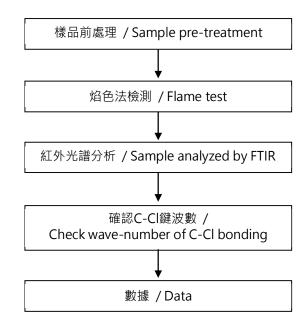
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聚氯乙烯物質判定分析流程圖 / Analysis flow chart - PVC

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元素(含重金屬)分析流程圖 / Analytical flow chart of elements (Heavy metal included)

根據以下的流程圖之條件·樣品已完全溶解。

These samples were dissolved totally by pre-conditioning method according to below flow chart.

【參考方法/Reference method: US EPA 3051A、US EPA 3052】

* US EPA 3051A 方法未添加氫氟酸 / US EPA 3051A method does not add HF.

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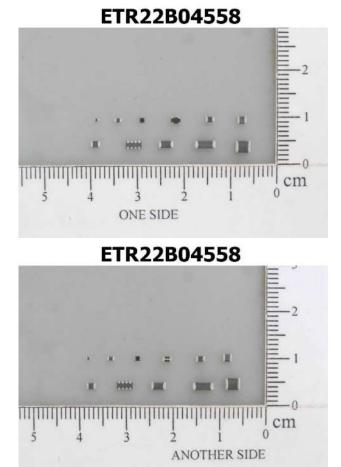
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照片中如有箭頭標示,則表示為實際檢測之樣品/部位. (The tested sample / part is marked by an arrow if it's shown on the photo.)



** 報告結尾 (End of Report) **

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